

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Chia-Chung WANG	09/27/2011
Charles W.C. LIN	09/27/2011
RECEIVING PARTY DATA	
Name:	Bridge Semiconductor Corporation
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13299472
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ATTORNEY DOCKET NUMBER:	LINC3114CIP/REF
NAME OF SUBMITTER:	Richard E. Fichter
Total Attachments: 2 source=LINC3314CIP_assignment#page1.tif source=LINC3314CIP_assignment#page2.tif	

CH \$40.00 13299472

ATTORNEY/DOCKET NO:

ASSIGNMENT BY INVENTOR(S) OF U.S. APPLICATION

WHEREAS, I am the original, first and sole inventor and I own (if only one name is listed below) or an original, first and joint inventor and the joint inventors own (if plural names are listed below) (referred to as "ASSIGNOR" below) the subject matter which is claimed and for which a patent is sought on the invention (referred to as the "INVENTION" below) entitled:

**Method of Making Thermally Enhanced Semiconductor Assembly
Title: with Bump/Base/Flange Heat Spreader and Build-Up Circuitry**

the specification of which (check one):

- is executed on even date herewith.
- was filed on (day-month-year) as U.S. Application Number
- was filed on (day-month-year) as PCT Application Number
- was executed on the following date(s) (day-month-year)

WHEREAS, **Bridge Semiconductor Corporation**

having a postal address of **3F, 157 Li-Te Rd., Peitou District, Taipei City, 11259 Taiwan R.O.C.**


(referred to as "ASSIGNEE" below) desires to acquire the entire right, title and interest in and to the same in the U.S.;

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy of which is hereby acknowledged, ASSIGNOR, by these presents does sell, assign and transfer unto ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all patents granted on any division, continuation, continuation-in-part and reissue of said application.

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent applications in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE's expense, to identify and communicate to ASSIGNEE at ASSIGNEE's request documents and information concerning the INVENTION that are within ASSIGNOR's possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR's obligations under this instrument shall extend to ASSIGNOR's heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all patents referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE's sole use and behoof; and for the use and behoof of ASSIGNEE's legal representatives and successors, to the full end of the term for which such patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

ASSIGNOR authorizes any member of the firm of Bacon & Thomas, PLLC to insert or complete any information in this document needed to effect its recordal in the U.S. Patent and Trademark Office.

Full Name of First or Sole Inventor Charles W.C. LIN	Post Office Address 18 Simei Rise #07-43
Citizenship U.S.A.	Residence (city, and either state or foreign country, MPEP §605.02) Singapore 528808
Date Sept. 27, 2011	Signature 

See following page(s) for additional joint inventors.

ATTORNEY/DOCKET NO:

**SUPPLEMENTAL PAGE FOR AN
ASSIGNMENT BY INVENTOR(S) OF U.S. APPLICATION**

Full Name of Joint Inventor Chia-Chung WANG	Post Office Address 3rd Floor, #12, Alley 33, Section 2, Jungshing Road
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Date <i>Sept. 27, 2011</i>	Signature <i>Chia-Chung Wang</i>

Full Name of Joint Inventor	Post Office Address
Citizenship	Residence (city, and either state or foreign country, MPEP §605.02)
Date	Signature

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Date	Signature

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Citizenship	Residence (city, and either state or foreign country, MPEP §605.02)
Date	Signature

See following page(s) for additional joint inventors.